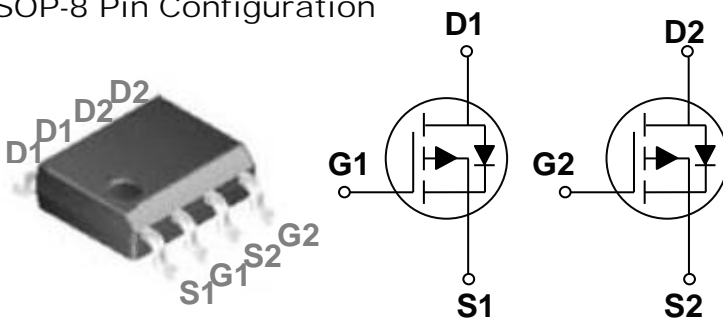## 30V P−Channel MOSFETs

General Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDSON	ID
-30V	23mΩ	-7A

Features

- *-30V,-7A, RDS(ON) =23mΩ @VGS = -10V*
- *Fast switching*
- *Green Device Available*
- *Suit for -4.5V Gate Drive Applications*

Applications

- *MB / VGA / Vcore*
- *POL Applications*
- *Load Switch*
- *LED Application*

SOP-8 Pin Configuration

Absolute Maximum Ratings (Tc= 25℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-30	V
V_{GS}	Gate-Source Voltage (base on I_{GSS1} condition)	± 20	V
V_{GS}	Gate-Source Voltage (base on I_{GSS2} condition)	± 25	V
I_D	Drain Current – Continuous (T$_C$=25℃)	-7	A
	Drain Current – Continuous (T$_C$=100℃)	-4.43	A
I_{DM}	Drain Current – Pulsed[1]	-28	A
EAS	Single Pulse Avalanche Energy[2]	61	mJ
IAS	Single Pulse Avalanche Current[2]	35	A
P_D	Power Dissipation (T$_C$=25℃)	2.1	W
	Power Dissipation – Derate above 25℃	0.017	W/℃
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{θJA}$	Thermal Resistance Junction to ambient	---	60	℃/W

30V P-Channel MOSFETs

Electrical Characteristics (T_J=25 ℃, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=-250uA	-30	---	---	V
$\triangle BV_{DSS}/\triangle T_J$	BV_{DSS} Temperature Coefficient	Reference to 25℃ , I_D=-1mA	---	-0.03	---	V/℃
I_{DSS}	Drain-Source Leakage Current	V_{DS}=-30V , V_{GS}=0V , T_J=25℃	---	---	-1	uA
		V_{DS}=-24V , V_{GS}=0V , T_J=125℃	---	---	-10	uA
I_{GSS1}	Gate-Source Leakage Current	V_{GS}=± 20V , V_{DS}=0V	---	---	± 100	nA
I_{GSS2}	Gate-Source Leakage Current	V_{GS}=± 25V , V_{DS}=0V	---	---	± 1	mA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=-10V , I_D=-5A	---	20	23	mΩ
		V_{GS}=-4.5V , I_D=-3A	---	30	36	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D =-250uA	-1.2	-1.6	-2.5	V
$\triangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	4	---	mV/℃
gfs	Forward Transconductance	V_{DS}=-10V , I_D=-3A	---	6.8	---	S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q_g	Total Gate Charge[3,4]	V_{DS}=-15V , V_{GS}=-4.5V , I_D=-5A	---	11	17	nC
Q_{gs}	Gate-Source Charge[3,4]		---	3.4	6	
Q_{gd}	Gate-Drain Charge[3,4]		---	4.2	8	
$T_{d(on)}$	Turn-On Delay Time[3,4]	V_{DD}=-15V , V_{GS}=-10V , R_G=6Ω I_D=-1A	---	5.8	11	ns
T_r	Rise Time[3,4]		---	18.8	36	
$T_{d(off)}$	Turn-Off Delay Time[3,4]		---	46.9	89	
T_f	Fall Time[3,4]		---	12.3	23	
C_{iss}	Input Capacitance	V_{DS}=-15V , V_{GS}=0V , F=1MHz	---	1250	1820	pF
C_{oss}	Output Capacitance		---	160	235	
C_{rss}	Reverse Transfer Capacitance		---	90	130	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	V_G=V_D=0V , Force Current	---	---	-7	A
I_{SM}	Pulsed Source Current		---	---	-14	A
V_{SD}	Diode Forward Voltage	V_{GS}=0V , I_S=-1A , T_J=25℃	---	---	-1	V

Note :
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=25V,V_{GS}=10V,L=0.1mH,I_{AS}=35A.,R_G=25Ω , Starting T_J=25℃.
3. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%.
4. Essentially independent of operating temperature.

30V P-Channel MOSFETs
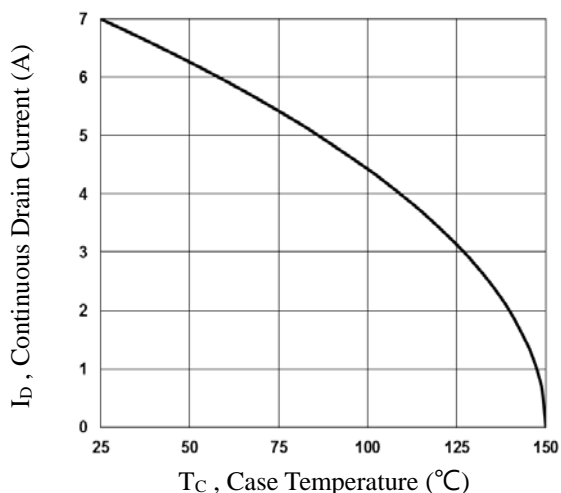

Fig.1　Continuous Drain Current vs. T$_C$

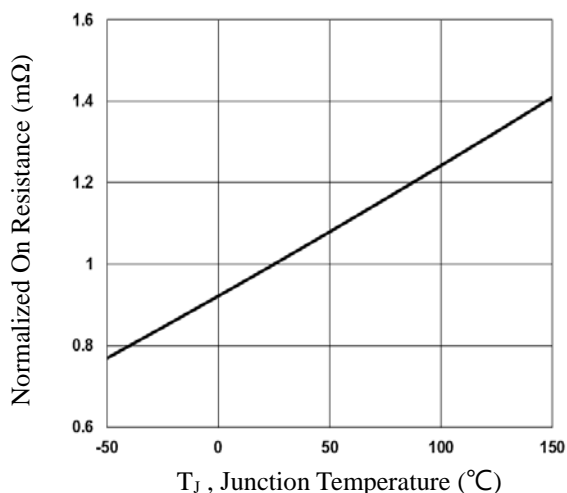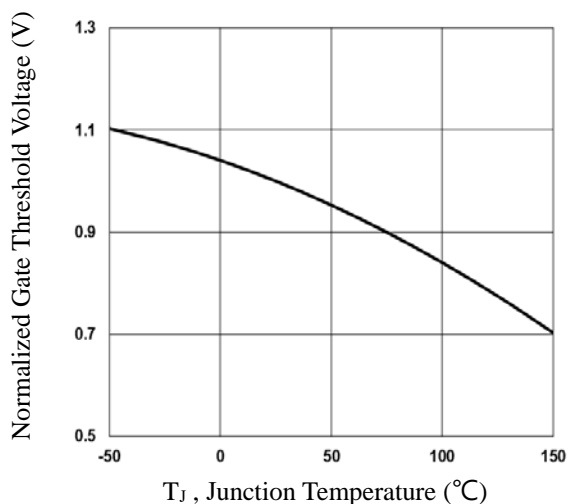Fig.2　Normalized RDSON vs. T$_J$

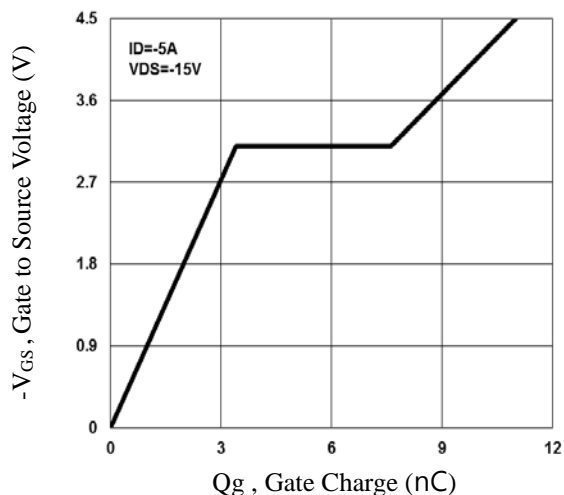Fig.3　Normalized V$_{th}$ vs. T$_J$
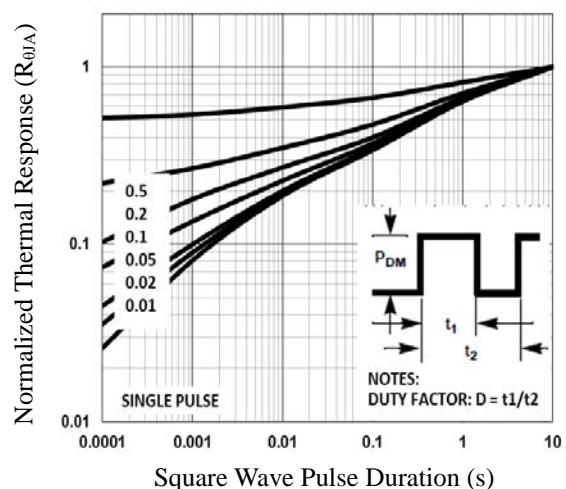

Fig.4　Gate Charge Waveform
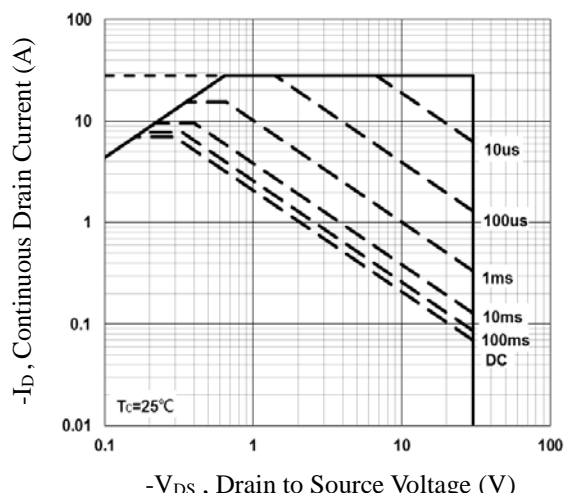

Fig.5　Normalized Transient Impedance

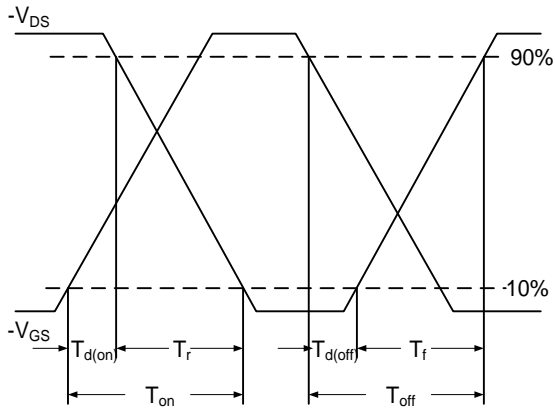Fig.6　Maximum Safe Operation Area

30V P−Channel MOSFETs

Fig.7　Switching Time Waveform

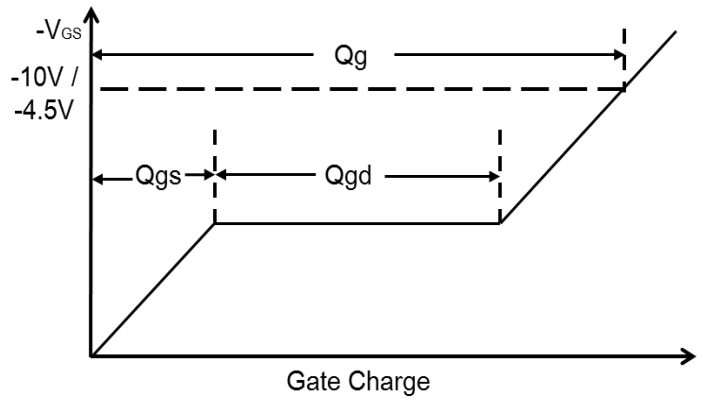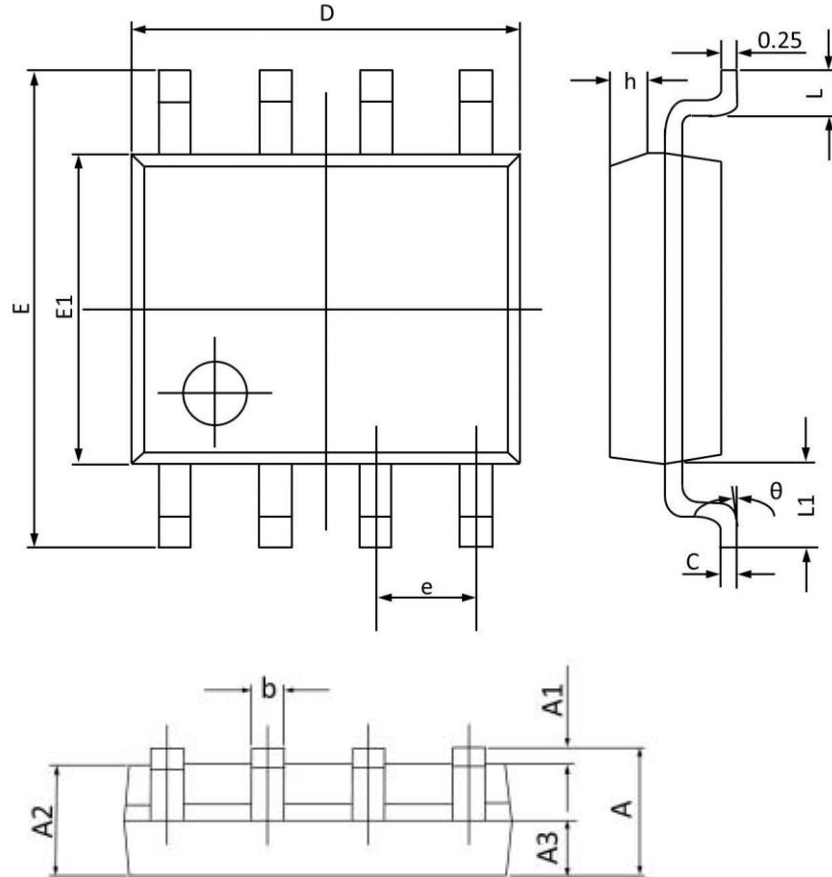**Fig.8　Gate Charge Waveform**

30V P−Channel MOSFETs

SOP-8 PACKAGE INFORMATION

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.068
A1	0.100	0.250	0.004	0.009
A2	1.300	1.500	0.052	0.059
A3	0.600	0.700	0.024	0.027
b	0.390	0.480	0.016	0.018
c	0.210	0.260	0.009	0.010
D	4.700	5.100	0.186	0.200
E	5.800	6.200	0.229	0.244
E1	3.700	4.100	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.250	0.500	0.010	0.019
L	0.500	0.800	0.019	0.031
L1	1.050(BSC)		0.041(BSC)	
Ө	0°	8°	0°	8°